

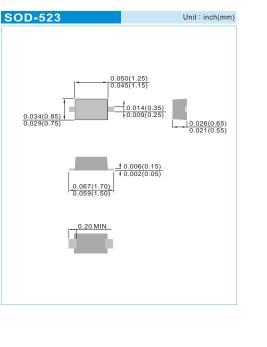
SURFACE MOUNT SILICON ZENER DIODES

5.1~8.2 Volt POWER 200 mWatt

FEATURES

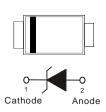
VOLTAGE

- Planar Die construction
- 200mW Power Dissipation
- Ideally Suited for Automated Assembly Processes
- Lead free in compliance with EU RoHS 2011/65/EU directive
- Green molding compound as per IEC61249 Std. . (Halogen Free)



MECHANICAL DATA

- Case: SOD-523, Molded Plastic
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx weight: 0.00005 ounces, 0.001 grams



MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Parameter	Symbol	Value	Units	
Maximum Power Dissipation (Notes A) at 25°C	Po	200	mW	
Operating Junction and StorageTemperature Range	TJ	-55 to +150	°C	

ELECTRICAL CHARACTERISTICS

Part Number	Nominal Zener Voltage			Max. Zener Impedance				Max. Reverse Leakage Current		Marking
	Vz @ Izt			Ζ <u></u> ζτ @ Ι ζτ		Z zк @ I zк		Ir@Vr		Code
	Nom. V	Min. V	Max. V	Ω	mA	Ω	mA	μA	V	
BZX584B5V1	5.1	5	5.2	60	5	480	1	2	2	W9
BZX584B5V6	5.6	5.49	5.71	40	5	400	1	1	2	WA
BZX584B8V2	8.2	8.04	8.36	15	5	80	1	0.7	5	WE

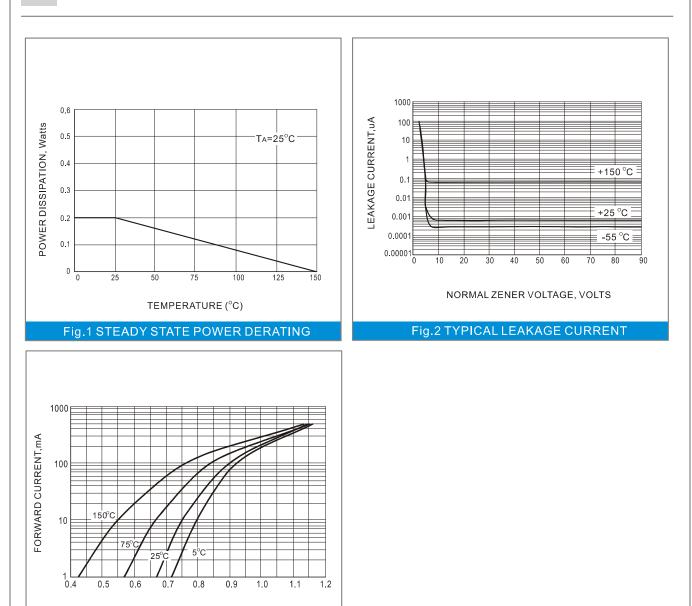
NOTES :

A. Mounted on an FR4 PCB, single-sided copper, mini pad.





BZX584B5V1 SERIES



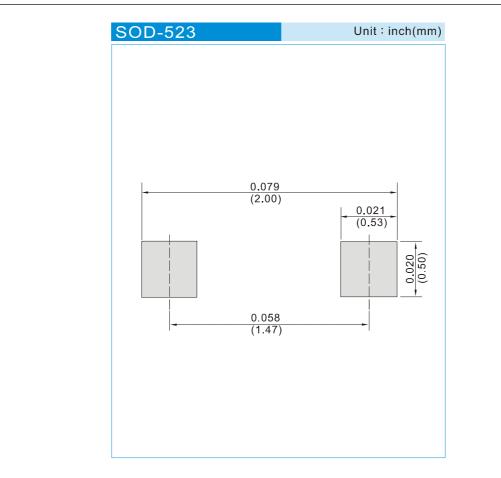
FORWARD VOLTAGE, VOLTS

Fig.3 TYPICAL FORWARD VOLTAGE



BZX584B5V1 SERIES

MOUNTING PAD LAYOUT



ORDER INFORMATION

Packing information

T/R - 12K per 13" plastic Reel

T/R - 5K per 7" plastic Reel



BZX584B5V1 SERIES									
Part No_packing code BZX584B5V1_R1_00001 BZX584B5V1_R2_00001	_Versi	on							
For example : RB500V-40_R2_00001 Part No. Version code means HF Packing size code means 13" Packing type means T/R									
	Packing Code XX					Version Code XXXXX			
Packing type	1 st Code	Packing size code	2 nd Code	HF or RoHS	1 st Code	2 nd ~5 th Code			
Tape and Ammunition Box (T/B)	Α	N/A	0	HF	0	serial number			
Tape and Reel (T/R)	R	7"	1	RoHS	1	serial number			
Bulk Packing (B/P)	В	13"	2						
Tube Packing (T/P)	т	26mm	X						
Tape and Reel (Right Oriented) (TRR)	S	52mm	Y						
Tape and Reel (Left Oriented) (TRL)	L	PANASERT T/B CATHODE UP (PBCU)	U						
FORMING	F	PANASERT T/B CATHODE DOWN (PBCD)	D						





BZX584B5V1 SERIES

Disclaimer

- Reproducing and modifying information of the document is prohibited without permission from Panjit International Inc..
- Panjit International Inc. reserves the rights to make changes of the content herein the document anytime without notification. Please refer to our website for the latest document.
- Panjit International Inc. disclaims any and all liability arising out of the application or use of any product including damages incidentally and consequentially occurred.
- Panjit International Inc. does not assume any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.
- Applications shown on the herein document are examples of standard use and operation. Customers are responsible in comprehending the suitable use in particular applications. Panjit International Inc. makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.
- The products shown herein are not designed and authorized for equipments requiring high level of reliability or relating to human life and for any applications concerning life-saving or life-sustaining, such as medical instruments, transportation equipment, aerospace machinery et cetera. Customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Panjit International Inc. for any damages resulting from such improper use or sale.
- Since Panjit uses lot number as the tracking base, please provide the lot number for tracking when complaining.

单击下面可查看定价,库存,交付和生命周期等信息

>>Panjit(强茂)